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# PS7205B-1A

# 4-PIN SOP, $0.9\,\Omega$ LOW ON-STATE RESISTANCE 80 V BREAK DOWN VOLTAGE 500 mA CONTINUOUS LOAD CURRENT 1-ch Optical Coupled MOS FET

-NEPOC Series-

#### **DESCRIPTION**

The PS7205B-1A is a low on-state resistance solid state relay containing a GaAs LED on the input side and MOS FETs on the output side.

It is suitable for PLC, etc. because of its large continuous load current and low on-state resistance.

#### **FEATURES**

- Low on-state resistance ( $R_{on} = 0.9 \Omega \text{ TYP.}$ )
- Large continuous load current (IL = 500 mA)
- High-speed switching time (ton, toff = 0.5 ms MAX.)
- 1 channel type (1 a output)
- · Designed for AC/DC switching line changer
- Small and thin package (4-pin SOP, Height = 2.1 mm)
- High isolation voltage (BV = 1 500 Vr.m.s.)
- · Low offset voltage
- Ordering number of taping product : PS7205B-1A-E3, E4: 900 pcs/reel

: PS7205B-1A-F3, F4: 3 500 pcs/reel

<R>

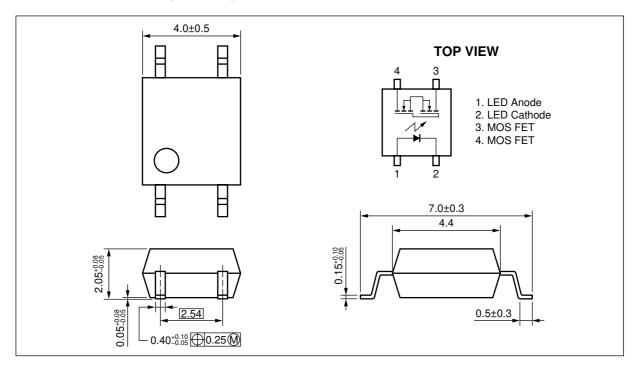
· Pb-Free product

## **APPLICATIONS**

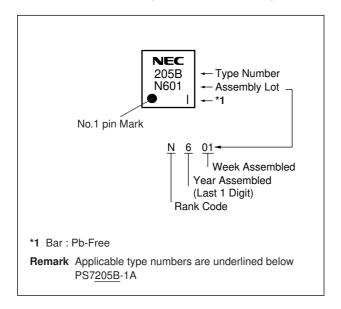
- · Measurement equipment
- FA equipment

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# PACKAGE DIMENSIONS (Unit: mm)



## <R> MARKING EXAMPLE (LASER MARKING)



#### <R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style
PS7205B-1A	PS7205B-1A-A	Pb-Free	Magazine case 100 pcs
PS7205B-1A-E3	PS7205B-1A-E3-A		Embossed Tape 900 pcs/reel
PS7205B-1A-E4	PS7205B-1A-E4-A		
PS7205B-1A-F3	PS7205B-1A-F3-A		Embossed Tape 3 500 pcs/reel
PS7205B-1A-F4	PS7205B-1A-F4-A		

## ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)	lF	50	mA	
	Reverse Voltage	VR	5.0	V	
	Power Dissipation	Po	50	mW	
	Peak Forward Current*1	IFP	1	Α	
MOS FET	MOS FET Break Down Voltage		80	V	
	Continuous Load Current	lL	500	mA	
	Pulse Load Current *2 (AC/DC Connection)	ILP	1	А	
	Power Dissipation	Po	300	mW	
Isolation Voltage*3		BV	1 500	Vr.m.s.	
Total Power Dissipation		Рт	350	mW	
Operating Ambient Temperature		Та	-40 to +85	°C	
Storage Temperature		T <sub>stg</sub>	-40 to +100	°C	

<sup>\*1</sup> PW = 100 μs, Duty Cycle = 1%

<sup>\*2</sup> PW = 100 ms, 1 shot

<sup>\*3</sup> AC voltage for 1 minute at  $T_A = 25^{\circ}C$ , RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.

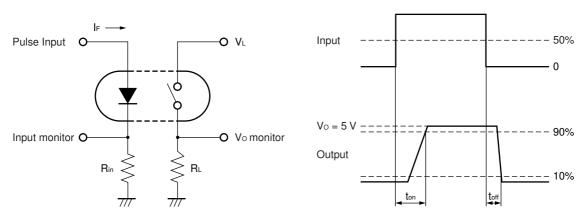
# RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	
LED Operating Current	lF	2	5	20	mA	
LED Off Voltage	VF	0		0.5	V	

## **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Diode Forward Voltage		I <sub>F</sub> = 5 mA		1.1	1.4	V
	Reverse Current	lR	V <sub>R</sub> = 5 V			5.0	μА
MOS FET	Off-state Leakage Current	Loff	V <sub>D</sub> = 80 V		0.15	5.0	nA
	Output Capacitance	Cout	V <sub>D</sub> = 0 V, f = 1 MHz		30		pF
Coupled	LED On-state Current	IFon	I∟ = 500 mA			2.0	mA
	On-state Resistance	Ron	$I_F = 5 \text{ mA}, I_L = 500 \text{ mA}, t \le 10 \text{ ms}$		0.9	1.2	Ω
	Turn-on Time *1, 2	ton	If = 5 mA, Vo = 5 V, RL = 500 $\Omega$ ,		0.18	0.5	ms
	Turn-off Time *1, 2	toff	PW ≥ 10 ms		0.04	0.5	
	Isolation Resistance	R <sub>I-O</sub>	Vi-o = 1.0 kVpc	10 <sup>9</sup>			Ω
	Isolation Capacitance	C <sub>I-O</sub>	V = 0 V, f = 1 MHz		0.5		pF

### \*1 Test Circuit for Switching Time

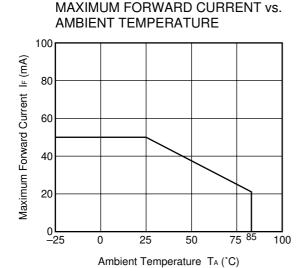


\*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.

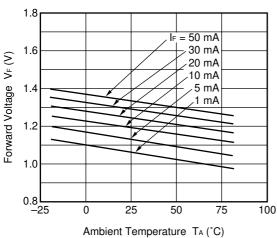
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

100

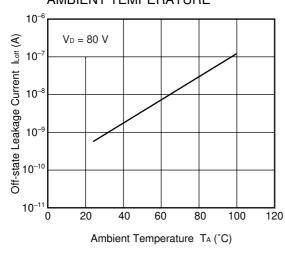
# TYPICAL CHARACTERISTICS (Ta = 25°C, unless otherwise specified)



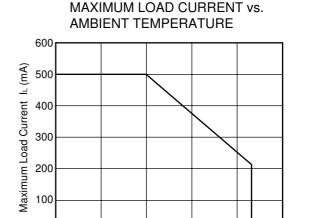




# OFF-STATE LEAKAGE CURRENT vs. AMBIENT TEMPERATURE



Remark The graphs indicate nominal characteristics.

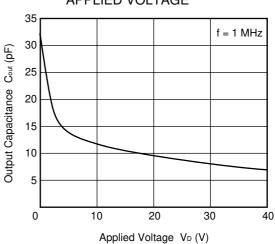


OUTPUT CAPACITANCE vs. APPLIED VOLTAGE

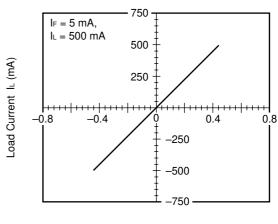
Ambient Temperature TA (°C)

25

0**∟** –25

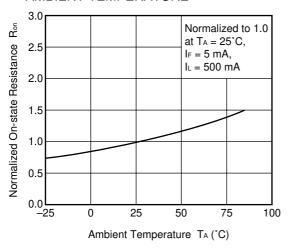


#### LOAD CURRENT vs. LOAD VOLTAGE

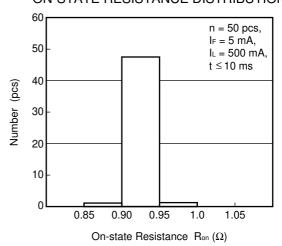


Load Voltage V<sub>L</sub> (V)

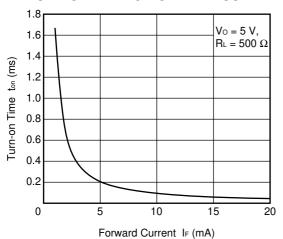
# NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



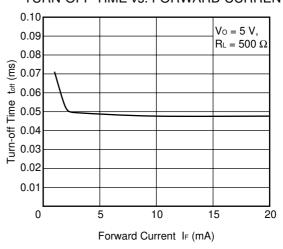
## ON-STATE RESISTANCE DISTRIBUTION



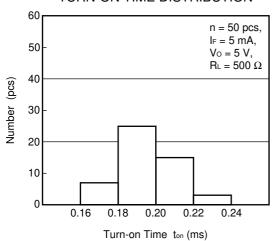
### TURN-ON TIME vs. FORWARD CURRENT



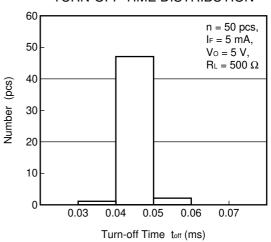
TURN-OFF TIME vs. FORWARD CURRENT



## TURN-ON TIME DISTRIBUTION

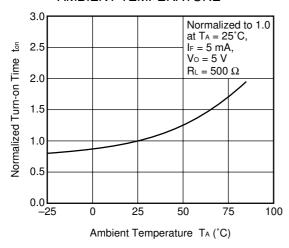


TURN-OFF TIME DISTRIBUTION



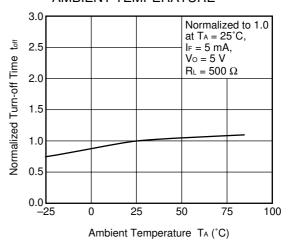
Remark The graphs indicate nominal characteristics.

# NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE

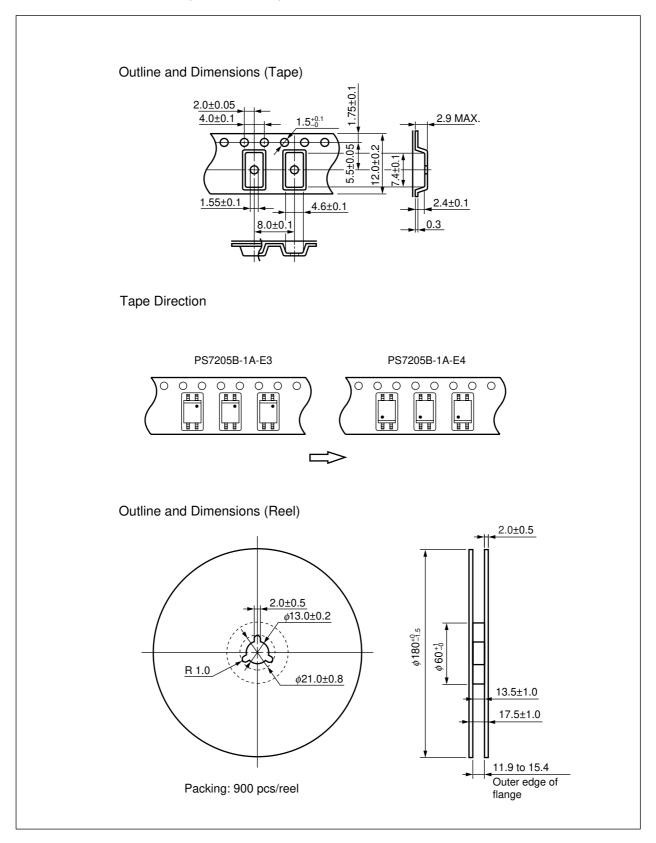


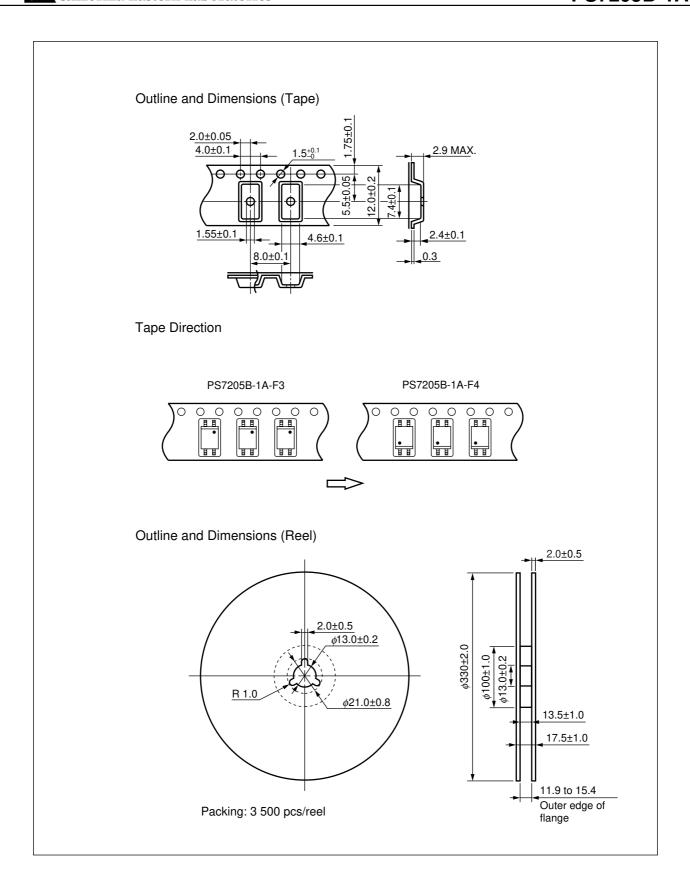
**Remark** The graphs indicate nominal characteristics.

# NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



## **TAPING SPECIFICATIONS (in millimeters)**





#### RECOMMENDED SOLDERING CONDITIONS

#### (1) Infrared reflow soldering

260°C or below (package surface temperature) · Peak reflow temperature

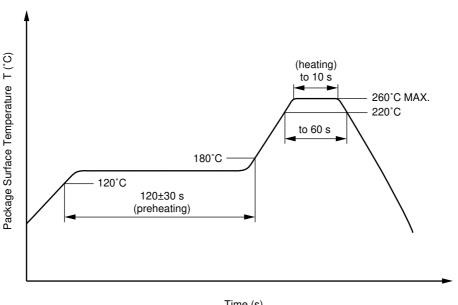
· Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

### (2) Wave soldering

 Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

#### <R> (3) Soldering by soldering iron

• Peak temperature (lead part temperature) 350°C or below · Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

### (4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

# <R> USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 02.11-1

#### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
  - 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

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